

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

**priority** Application Serial No. ....10/227,500  
**priority** Filing Date .....August 22, 2002  
Inventor.....Wendell P. Noble  
Assignee.....Micron Technology, Inc.  
**priority** Group Art Unit.....2813  
**priority** Examiner ..... L. Schillinger  
Attorney's Docket No. ....MI22-2378  
Title: Semiconductor Processing Methods of Forming Integrated Circuitry,  
Forming Conductive Lines, Forming a Conductive Grid, Forming a  
Conductive Network, Forming an Electrical Interconnection to a Node  
Location, Forming an Electrical Interconnection with a Transistor  
Source/Drain Region, and Integrated Circuitry

**PRELIMINARY AMENDMENT**

To: Commissioner for Patents  
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**AMENDMENTS**

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